

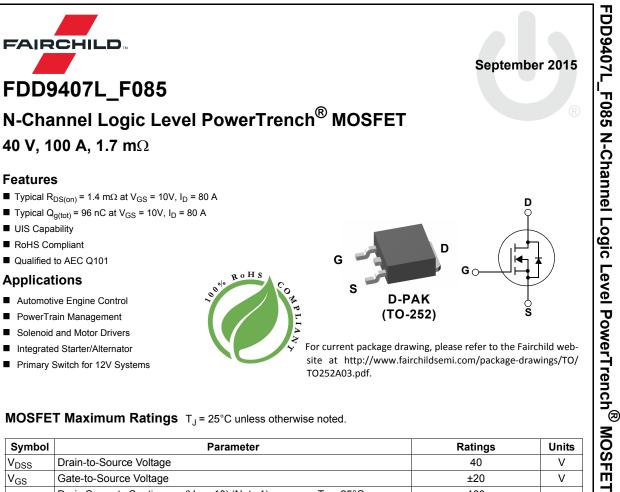
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MOSFET Maximum Ratings T₁ = 25°C unless otherwise noted.

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-to-Source Voltage		40	V	
V _{GS}	Gate-to-Source Voltage		±20	V	
I _D	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C =25°C	100		
	Pulsed Drain Current	T _C = 25°C	See Figure 4	A	
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	128	mJ	
P _D	Power Dissipation		227	W	
	Derate Above 25°C		1.52	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 175	°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.66	°C/W	
R _{0JA}	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	52	°C/W	

Notes:

1: Current is limited by bondwire configuration.

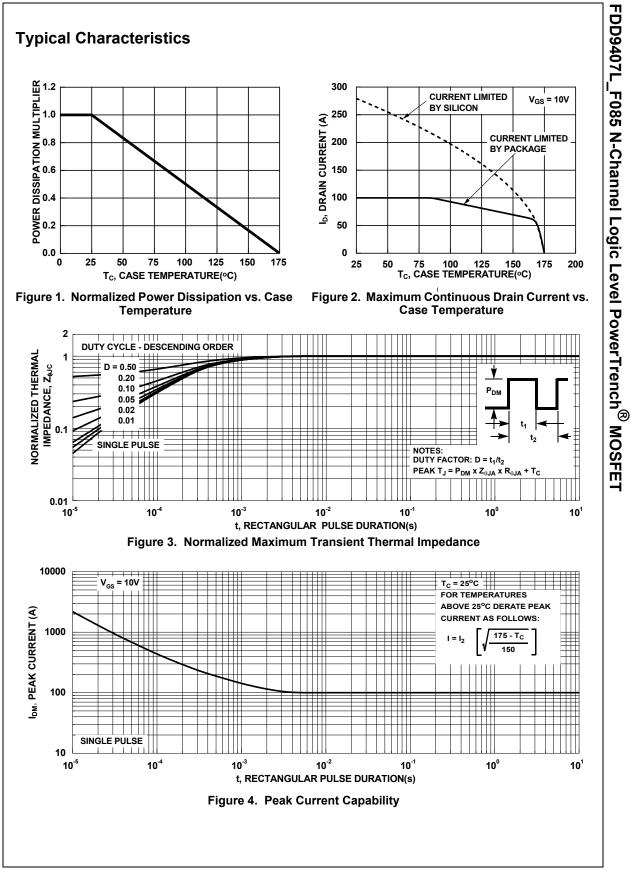
2: Starting $T_J = 25^{\circ}$ C, $L = 40\mu$ H, $I_{AS} = 80$ A, $V_{DD} = 40$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.

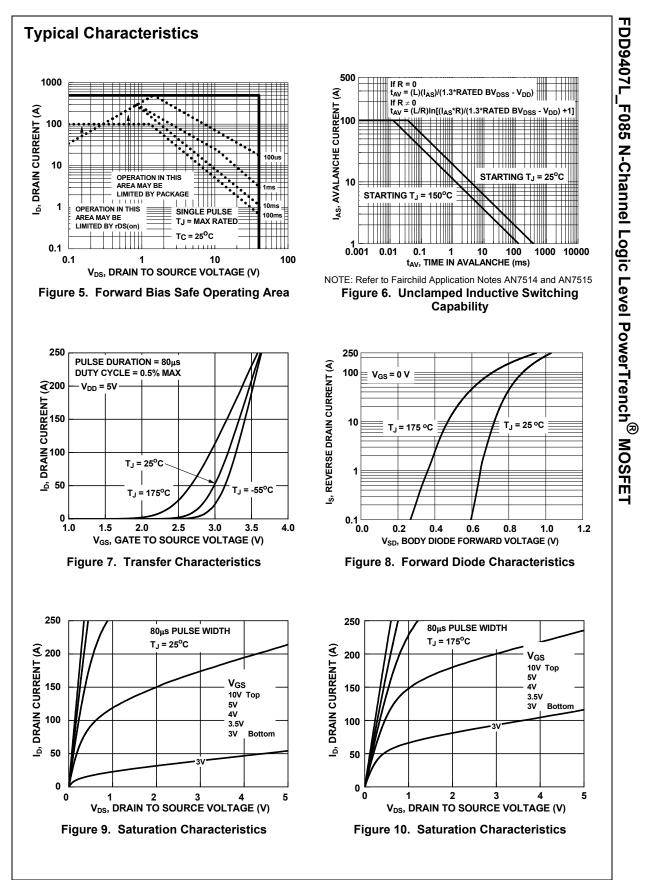
3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

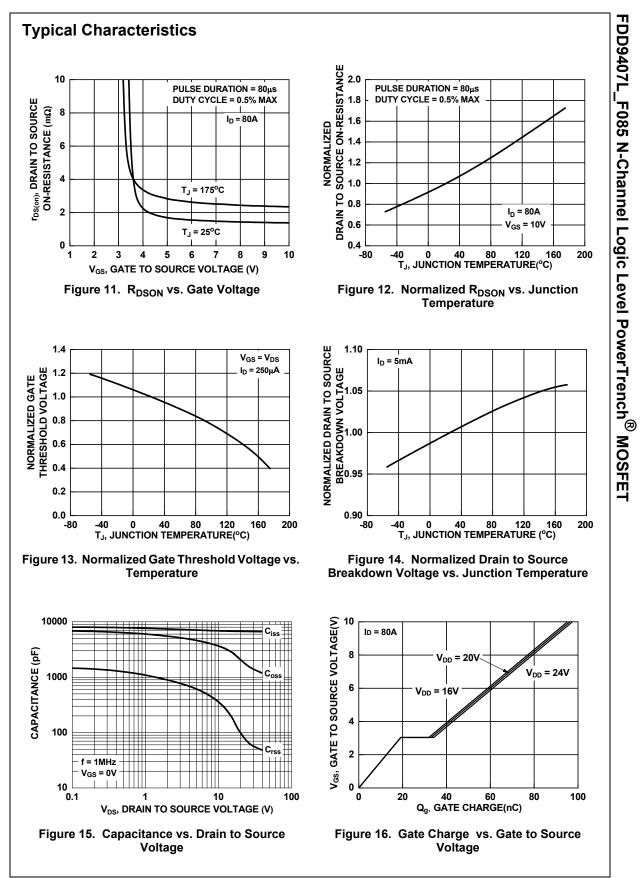
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD9407L	FDD9407L_F085	D-PAK(TO-252)	13"	16mm	2500units

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
Off Cha	racteristics						
B _{VDSS}	Drain-to-Source Breakdown Voltage	I _D = 250μA, V	(_{GS} = 0V	40	-	-	V
		V _{DS} =40V,		-	-	1	μA
I _{DSS}	Drain-to-Source Leakage Current	$V_{GS} = 0V$	$T_{\rm J} = 175^{\rm o}C$ (Note 4)	-	-	1	mA
I _{GSS}	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$	• • • •	-	-	±100	nA
On Cha	racteristics			-			
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250μA		1	1.8	3	V
· (3)(iii)			$I_D = 80A, V_{GS} = 4.5V$		1.9	2.4	mΩ
R _{DS(on)}	Drain to Source On Resistance	I _D = 80A,		-	1.4	1.7	mΩ
03(01)			T _J = 175 ^o C (Note 4)	-	2.4	2.9	mΩ
•					6700		۶E
C _{iss}	Input Capacitance Output Capacitance	− V _{DS} = 25V, V _{GS} = 0V, f = 1MHz		-	1640	-	pF pF
C _{oss}	Reverse Transfer Capacitance			-		-	pr pF
Prss	Gate Resistance	V _{GS} = 0.5V, f = 1MHz		-	68 2.1	-	•
۲ _g				-		- 125	Ω nC
Q _{g(ToT)}	Total Gate Charge	$V_{GS} = 0$ to 10	• • • • • • •	-	96 12	120	
Q _{g(th)}	Threshold Gate Charge Gate-to-Source Gate Charge	V_{GS} = 0 to 2V	/ I _D = 80A	-	12	-	nC nC
Q _{gs} Q _{gd}	Gate-to-Drain "Miller" Charge		-	-	10	-	nC
	ng Characteristics					1	
on	Turn-On Time	V_{DD} = 20V, I _D = 80A, V _{GS} = 10V, R _{GEN} = 6Ω		-	-	68	ns
d(on)	Turn-On Delay			-	17	-	ns
r	Rise Time			-	35	-	ns
t _{d(off)}	Turn-Off Delay			-	58	-	ns
t _f	Fall Time			-	21	-	ns
off	Turn-Off Time			-	-	104	ns
)rain-S	ource Diode Characteristics						
	Source-to-Drain Diode Voltage	I _{SD} = 80A, V ₀		-	-	1.25	V
1/	Source-to-Drain Diode Voltage	I _{SD} = 40A, V ₀	_{GS} = 0V	-	-	1.2	V
/ _{SD}		V _{DD} = 32V, I _F = 80A,		-	82	107	ns
/ _{SD}	Reverse-Recovery Time		dl _{SD} /dt = 100A/μs		106	138	nC







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